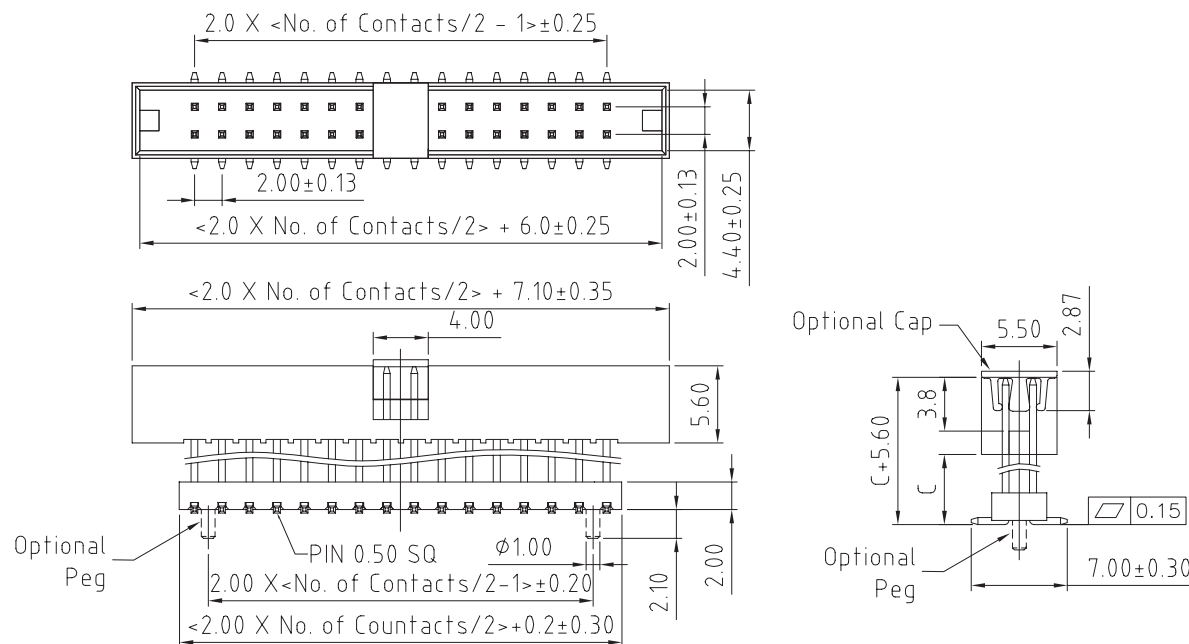


BB02-FW :- 2.00mm X 2.00mm (0.079" X 0.079") BOX HEADER, DUAL ROW, STRAIGHT, SMT TYPE, 06 TO 50 CONTACTS, BOARD SPACER

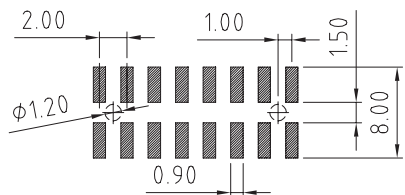
SPECIFICATIONS :

CURRENT RATING	2 AMP
INSULATOR RESISTANCE	1000 MEGOHMS MIN.
CONTACT RESISTANCE	20 m OHMS MAX.
DIELECTRIC WITHSTANDING	AC 500 V
OPERATING TEMPERATURE	-40°C TO +105°C
CONTACT MATERIAL	PHOSPHOR BRONZE
INSULATOR MATERIAL	THERMOPLASTIC, UL 94V-0
	STANDARD: NYLON-6T
PLATING	GOLD, TIN, OR SELECTIVE OVER 30-50U" NICKEL
SOLDERABILITY:	IR REFLOW: 260°C FOR 10 SEC
	MANUAL SOLDER: 350°C FOR 3-5 SEC

MATES WITH: - BB02-GH BB02-RJ  
BB02-GP BB02-RL  
BB02-GQ  
BB02-GZ  
BB02-RG



## HOW TO ORDER



(TOLERANCE:  $\pm 0.05$ )  
RECOMMENDED PC BOARD LAYOUT

NO. OF CONTACTS  
08 TO 50 (WITH PEG)  
06 TO 50 (WITHOUT PEG)

CONTACT PLATING OPTIONS

K = GOLD FLASH (STANDARD)

A = 10U" GOLD ON CONTACT/GOLD FLASH ON TAIL

B = 15U" GOLD ON CONTACT/GOLD FLASH ON TAIL

C = 30U" GOLD ON CONTACT/GOLD FLASH ON TAIL

T = BRIGHT TIN

M = MATT TIN

D = GOLD FLASH ON CONTACT/BRIGHT TIN ON TAIL

E = 10U" GOLD ON CONTACT/BRIGHT TIN ON TAIL

F = 15U" GOLD ON CONTACT/BRIGHT TIN ON TAIL

G = 30U" GOLD ON CONTACT/BRIGHT TIN ON TAIL

PACKAGING OPTIONS  
3 - TUBE  
5 - TUBE & CAP  
6 - T & R  
8 - T & R & CAP  
STANDARD = 3

PIN LENGTH C (1/10mm)  
PLEASE SPECIFY PIN  
LENGTH REQUIRED  
I.E 5,0mm = 050  
MINIMUM = 025  
MAXIMUM = 200  
TOL.  $\pm 0.25$ mm

LOCATING PEG OPTIONS:  
A = WITH PEGS  
B = WITHOUT PEGS